

MOSFET – Power, Single, N-Channel

60 V, 27.5 mΩ, 21 A

NTMYS025N06CL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- LFPAK4 Package, Industry Standard
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage	Э		V _{GS}	±20	V
Continuous Drain	Steady State	T _C = 25°C	I _D	21	Α
Current R _{θJC} (Notes 1, 2, 3)	State	T _C = 100°C		12	
Power Dissipation		T _C = 25°C	P_{D}	24	W
R _{θJC} (Notes 1, 2)		T _C = 100°C		7.6	
Continuous Drain	Steady State	T _A = 25°C	I _D	8.5	Α
Current R _{θJA} (Notes 1, 2, 3)	State	T _A = 100°C		6.0	
Power Dissipation	T _A = 25°C		P_{D}	3.8	W
R _{θJA} (Notes 1, 2)		T _A = 100°C		1.9	
Pulsed Drain Current $T_A = 25^{\circ}C$, $t_p = 10 \mu s$		I _{DM}	103	Α	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	20	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 1.5 A)			E _{AS}	44.6	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

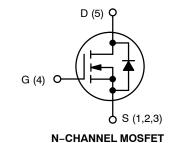
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	6.0	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39.5	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	27.5 mΩ @ 10 V	01.4
00 V	43 mΩ @ 4.5 V	21 A





LFPAK4 CASE 760AB



025N06CL = Specific Device Code A = Assembly Location

WL = Wafer Lot
 Y = Year
 W = Work Week

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	_	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,			-	10	μΑ
		V _{DS} = 60 V	T _J = 125°C	-	-	250	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$	V	-	-	100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 13 μ	A	1.2	-	2.0	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7.5 A	_	22.9	27.5	mΩ
		V _{GS} = 4.5 V	I _D = 7.5 A	_	35.8	43	
Forward Transconductance	9FS	V _{DS} = 15 V, I _D = 10 A		-	20	-	S
CHARGES, CAPACITANCES & GATE RES	ISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz	V _{DS} = 25 V	-	330	-	pF
Output Capacitance	C _{OSS}]		-	172	-	
Reverse Transfer Capacitance	C _{RSS}	1		-	5	-	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 48	3 V; I _D = 7.5 A	-	5.8	-	nC
Threshold Gate Charge	Q _{G(TH)}	1		-	0.8	-	
Gate-to-Source Charge	Q_{GS}			-	1.3	-	
Gate-to-Drain Charge	Q_{GD}			-	0.6	-	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 48$	8 V; I _D = 7.5 A	-	2.7	-	nC
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t _{d(ON)}	V _{GS} = 10 V, V _{DS} = 48	3 V,	-	5	_	ns
Rise Time	t _r	$I_D = 7.5 \text{ A}, R_G = 1.0 \text{ G}$	2	-	12.5	-	
Turn-Off Delay Time	t _{d(OFF)}			-	14	-	
Fall Time	t _f			-	2.5	-	
DRAIN-SOURCE DIODE CHARACTERIST	ics						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$	-	0.87	1.2	V
		I _S = 7.5 A	T _J = 125°C	-	0.76	-	
Reverse Recovery Time	t _{RR}	$V_{GS} = 0$ V, dIS/dt = 20 A/ μ s, $I_{S} = 7.5$ A		-	18	-	ns
Charge Time	ta			-	8.3	-	
Discharge Time	t _b			-	9.7	-	
Reverse Recovery Charge	Q _{RR}			-	7.5	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

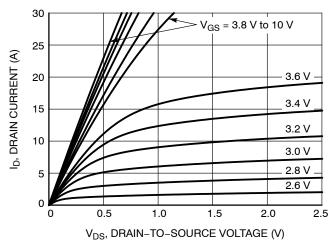


Figure 1. On-Region Characteristics

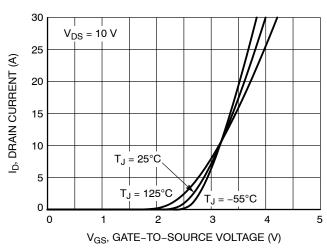


Figure 2. Transfer Characteristics

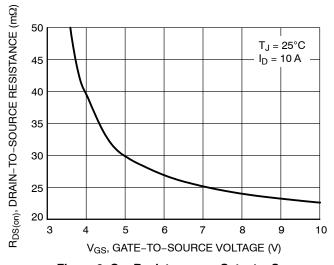


Figure 3. On-Resistance vs. Gate-to-Source Voltage

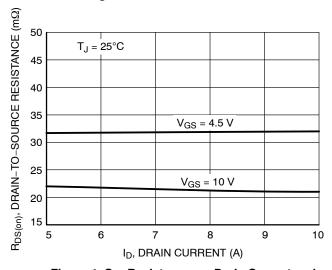


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

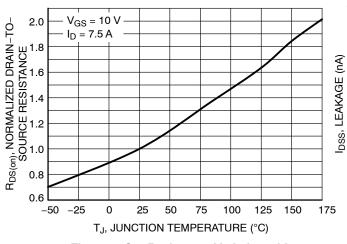


Figure 5. On–Resistance Variation with Temperature

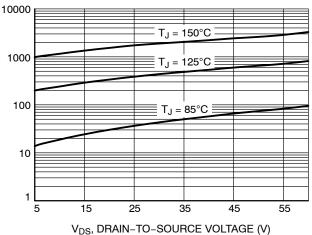


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

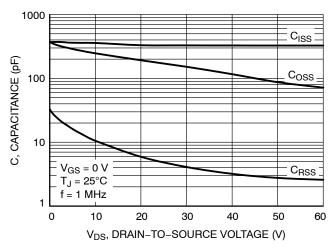


Figure 7. Capacitance Variation

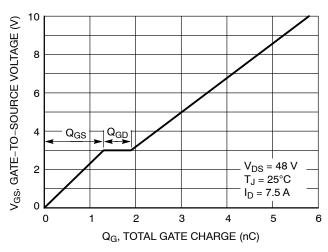


Figure 8. Gate-to-Source vs. Total Charge

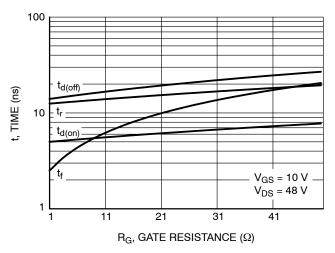


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

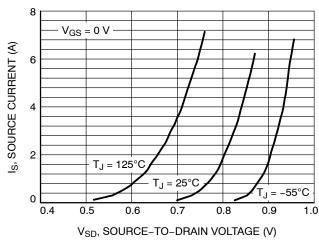


Figure 10. Diode Forward Voltage vs. Current

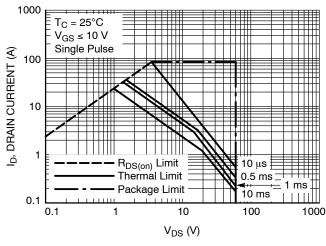


Figure 11. Maximum Rated Forward Biased Safe Operating Area

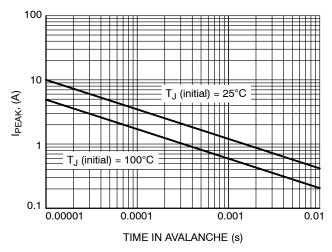


Figure 12. $I_{\mbox{\scriptsize PEAK}}$ vs. Time in Avalanche

TYPICAL CHARACTERISTICS

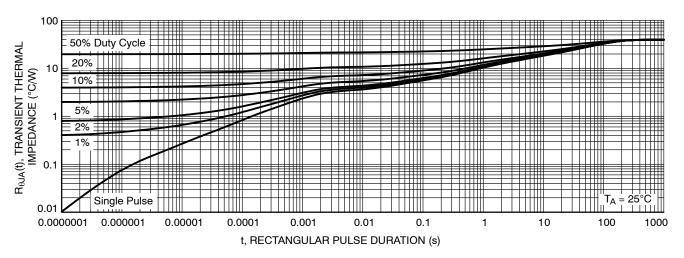


Figure 13. Thermal Response

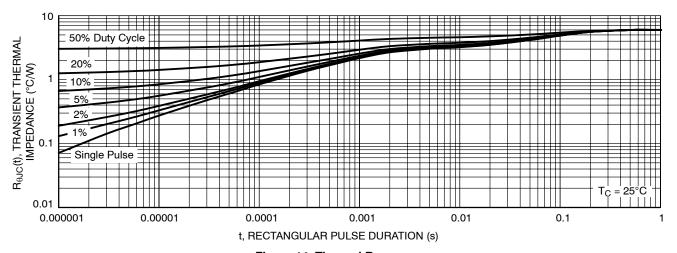


Figure 14. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMYS025N06CLTWG	025N06CL	LFPAK4 (Pb-Free)	3,000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

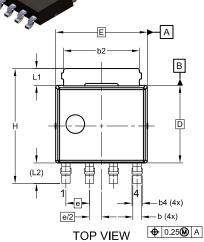


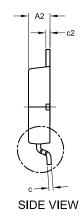
LFPAK4 4.90x4.15x1.15MM, 1.27P CASE 760AB

ISSUE D

1.30

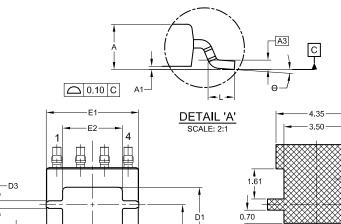
DATE 22 MAY 2024





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS.
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.150mm PER SIDE.
- 4. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.



D4

(D8)

-	1.61
1	0.70
	↑
,	1.15
	0.70 - - 1.27 -
	RECOMMENDED LAND PATTERN
	*FOR ADDITIONAL INFORMATION ON OUR
	PB-FREE STRATEGY AND SOLDERING
	I B THEE OH WILLIAM GOLDLINIA

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*

BOTTOM VIEW

D5

D6 (D7)

XXXXXX XXXXXX AWLYW XXXXXX = Specific Device Code A = Assembly Location

WL = Wafer Lot Y = Year W = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Some products may not follow the Generic Marking.

DIM MIN NOM MAX A 1.10 1.20 1.30 A1 0.00 0.08 0.15 A2 1.10 1.15 1.20 A3 0.25 BSC 0.50 b 0.40 0.45 0.50 b2 3.80 4.10 4.40 b4 0.45 0.55 0.65 c 0.19 0.22 0.25 c2 0.19 0.22 0.25 D 4.15 BSC 0.20 0.25 D1 3.80 4.00 4.20 D2 3.00 3.10 3.20 D3 0.30 0.40 0.50 D4 0.90 1.00 1.10 D5 0.70 0.80 0.90 D6 0.55 0.65 0.75 D7 0.31 REF D8 0.40 REF E 4.90 BSC E1 4.85 4.95 <td< th=""><th colspan="6">MILLIMETER</th></td<>	MILLIMETER						
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b 0.40 0.45 0.50 b2 3.80 4.10 4.40 b4 0.45 0.55 0.65 c 0.19 0.22 0.25 c2 0.19 0.22 0.25 D 4.15 BSC D1 3.80 4.00 4.20 D2 3.00 3.10 3.20 D3 0.30 0.40 0.50 D4 0.90 1.00 1.10 D5 0.70 0.80 0.90 D6 0.55 0.65 0.75 D7 0.31 REF B8 0.40 REF E 4.90 BSC E1 4.85 4.95 5.05 E2 3.10 3.20 3.30 E3 0.00 0.10 0.20 E4 2.00 2.10 2.20 e 1.27 BSC e/2 0.635 BSC e1 0.40 REF	A2	1.10	1.15	1.20			
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D8 0.40 REF E 4.90 BSC E1 4.85 4.95 5.05 E2 3.10 3.20 3.30 E3 0.00 0.10 0.20 E4 2.00 2.10 2.20 e 1.27 BSC e/2 0.635 BSC e1 0.40 REF H 6.00 6.15 6.30 L 0.50 0.70 0.90 L1 0.80 0.90 1.00 L2 1.10 REF	D6	0.55	0.65	0.75			
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L1 0.80 0.90 1.00 L2 1.10 REF							
L2 1.10 REF	L						
L2 1.10 REF Θ 0° 4° 8°	L1						
Θ 0° 4° 8°		1.10 REF					
	θ	0°	4°	8°			

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